

## 74AC175 • 74ACT175 Quad D-Type Flip-Flop

### General Description

The AC/ACT175 is a high-speed quad D-type flip-flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D-type inputs is stored during the LOW-to-HIGH clock transition. Both true and complemented outputs of each flip-flop are provided. A Master Reset input resets all flip-flops, independent of the Clock or D-type inputs, when LOW.

### Features

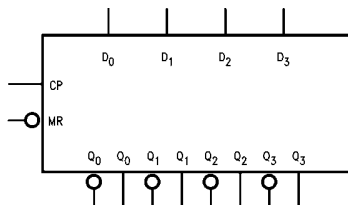
- $I_{CC}$  reduced by 50%
- Edge-triggered D-type inputs
- Buffered positive edge-triggered clock
- Asynchronous common reset
- True and complement output
- Outputs source/sink 24 mA
- ACT175 has TTL-compatible inputs

### Ordering Code:

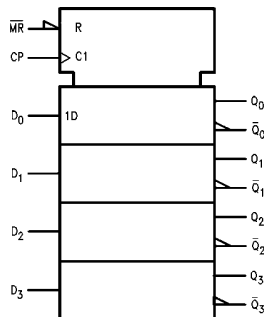
Order Number	Package Number	Package Description
74AC175SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Body
74AC175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74AC175MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74AC175PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
74ACT175SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Body
74ACT175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74ACT175MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74ACT175PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

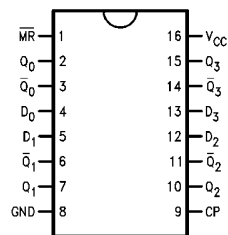
### Logic Symbols



IEEE/IEC



### Connection Diagram



### Pin Descriptions

Pin Names	Description
$D_0$ – $D_3$	Data Inputs
CP	Clock Pulse Input
$\overline{MR}$	Master Reset Input
$Q_0$ – $Q_3$	True Outputs
$\overline{Q_0}$ – $\overline{Q_3}$	Complement Outputs

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### Functional Description

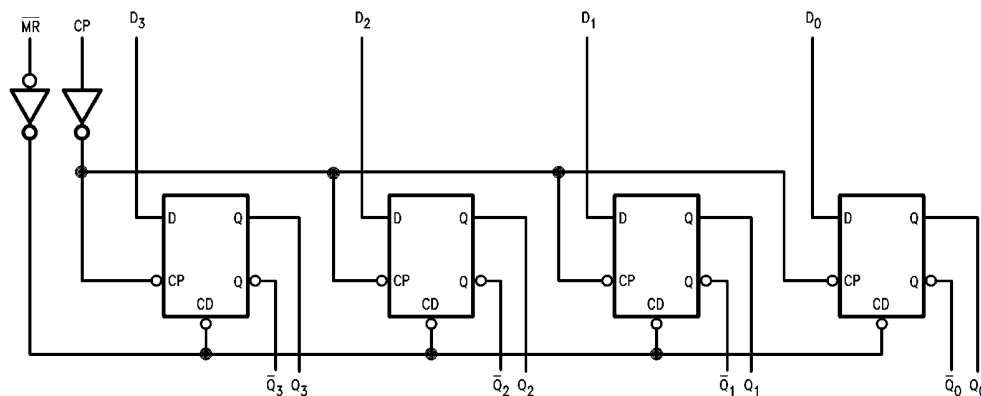
The AC/ACT175 consists of four edge-triggered D-type flip-flops with individual D inputs and Q and  $\bar{Q}$  outputs. The Clock and Master Reset are common. The four flip-flops will store the state of their individual D inputs on the LOW-to-HIGH clock (CP) transition, causing individual Q and  $\bar{Q}$  outputs to follow. A LOW input on the Master Reset ( $\bar{MR}$ ) will force all Q outputs LOW and  $\bar{Q}$  outputs HIGH independent of Clock or Data inputs. The AC/ACT175 is useful for general logic applications where a common Master Reset and Clock are acceptable.

### Truth Table

Inputs	Outputs	
@ $t_n, \bar{MR} = H$	@ $t_{n+1}$	
$D_n$	$Q_n$	$\bar{Q}_n$
L	L	H
H	H	L

H = HIGH Voltage Level  
 L = LOW Voltage Level  
 $t_n$  = Bit Time before Clock Pulse  
 $t_{n+1}$  = Bit Time after Clock Pulse

### Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

**Absolute Maximum Ratings**(Note 1)

Supply Voltage ( $V_{CC}$ )	-0.5V to +7.0V
DC Input Diode Current ( $I_{IK}$ )	
$V_I = -0.5V$	-20 mA
$V_I = V_{CC} + 0.5V$	+20 mA
DC Input Voltage ( $V_I$ )	-0.5V to $V_{CC} + 0.5V$
DC Output Diode Current ( $I_{OK}$ )	
$V_O = -0.5V$	-20 mA
$V_O = V_{CC} + 0.5V$	+20 mA
DC Output Voltage ( $V_O$ )	-0.5V to $V_{CC} + 0.5V$
DC Output Source	
or Sink Current ( $I_O$ )	$\pm 50$ mA
DC $V_{CC}$ or Ground Current	
per Output Pin ( $I_{CC}$ or $I_{GND}$ )	$\pm 50$ mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C
Junction Temperature ( $T_J$ )	
PDIP	140°C

**Recommended Operating Conditions**

Supply Voltage ( $V_{CC}$ )	
AC	2.0V to 6.0V
ACT	4.5V to 5.5V
Input Voltage ( $V_I$ )	0V to $V_{CC}$
Output Voltage ( $V_O$ )	0V to $V_{CC}$
Operating Temperature ( $T_A$ )	-40°C to +85°C
Minimum Input Edge Rate ( $\Delta V/\Delta t$ )	
AC Devices	
$V_{IN}$ from 30% to 70% of $V_{CC}$	
$V_{CC}$ @ 3.3V, 4.5V, 5.5V	125 mV/ns
Minimum Input Edge Rate ( $\Delta V/\Delta t$ )	
ACT Devices	
$V_{IN}$ from 0.8V to 2.0V	
$V_{CC}$ @ 4.5V, 5.5V	125 mV/ns

**Note 1:** Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications

**DC Electrical Characteristics for AC**

Symbol	Parameter	$V_{CC}$ (V)	$T_A = +25^\circ\text{C}$		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions
			Typ	Guaranteed Limits				
$V_{IH}$	Minimum HIGH Level Input Voltage	3.0	1.5	2.1	2.1	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$	
		4.5	2.25	3.15	3.15			
		5.5	2.75	3.85	3.85			
$V_{IL}$	Maximum LOW Level Input Voltage	3.0	1.5	0.9	0.9	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$	
		4.5	2.25	1.35	1.35			
		5.5	2.75	1.65	1.65			
$V_{OH}$	Minimum HIGH Level Output Voltage	3.0	2.99	2.9	2.9	V	$I_{OUT} = -50 \mu A$	
		4.5	4.49	4.4	4.4			
		5.5	5.49	5.4	5.4			
			3.0		2.56	2.46	V	$V_{IN} = V_{IL}$ or $V_{IH}$ $I_{OH} = -12$ mA $I_{OH} = -24$ mA $I_{OH} = -24$ mA (Note 2)
			4.5		3.86	3.76		
			5.5		4.86	4.76		
$V_{OL}$	Maximum LOW Level Output Voltage	3.0	0.002	0.1	0.1	V	$I_{OUT} = 50 \mu A$	
		4.5	0.001	0.1	0.1			
		5.5	0.001	0.1	0.1			
			3.0		0.36	0.44	V	$V_{IN} = V_{IL}$ or $V_{IH}$ $I_{OL} = 12$ mA $I_{OL} = 24$ mA $I_{OL} = 24$ mA (Note 2)
			4.5		0.36	0.44		
			5.5		0.36	0.44		
$I_{IN}$ (Note 4)	Maximum Input Leakage Current	5.5		$\pm 0.1$	$\pm 1.0$	$\mu A$	$V_I = V_{CC}, GND$	
$I_{OLD}$	Minimum Dynamic	5.5			75	mA	$V_{OLD} = 1.65V$ Max	
$I_{OHD}$	Output Current (Note 3)	5.5			-75	mA	$V_{OHD} = 3.85V$ Min	
$I_{CC}$ (Note 4)	Maximum Quiescent Supply Current	5.5		4.0	40.0	$\mu A$	$V_{IN} = V_{CC}$ or GND	

**Note 2:** All outputs loaded; thresholds on input associated with output under test.

**Note 3:** Maximum test duration 2.0 ms, one output loaded at a time.

**Note 4:**  $I_{IN}$  and  $I_{CC}$  @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V  $V_{CC}$ .

DC Electrical Characteristics for ACT								
Symbol	Parameter	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C		Units	Conditions
			Typ	Guaranteed Limits				
V <sub>IH</sub>	Minimum HIGH Level Input Voltage	4.5	1.5	2.0	2.0	V	V <sub>OUT</sub> = 0.1V or V <sub>CC</sub> - 0.1V	
		5.5	1.5	2.0	2.0			
V <sub>IL</sub>	Maximum LOW Level Input Voltage	4.5	1.5	0.8	0.8	V	V <sub>OUT</sub> = 0.1V or V <sub>CC</sub> - 0.1V	
		5.5	1.5	0.8	0.8			
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	4.5	4.49	4.4	4.4	V	I <sub>OUT</sub> = -50 μA	
		5.5	5.49	5.4	5.4			
			4.5		3.86	3.76	V	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> I <sub>OH</sub> = -24 mA I <sub>OH</sub> = -24 mA (Note 5)
			5.5		4.86	4.76		
V <sub>OL</sub>	Maximum LOW Level Output Voltage	4.5	0.001	0.1	0.1	V	I <sub>OUT</sub> = 50 μA	
		5.5	0.001	0.1	0.1			
			4.5		0.36	0.44	V	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> I <sub>OL</sub> = 24 mA I <sub>OL</sub> = 24 mA (Note 5)
			5.5		0.36	0.44		
I <sub>IN</sub>	Maximum Input Leakage Current	5.5		±0.1	±1.0	μA	V <sub>I</sub> = V <sub>CC</sub> , GND	
I <sub>CC1</sub>	Maximum I <sub>CC</sub> /Input	5.5	0.6		1.5	mA	V <sub>I</sub> = V <sub>CC</sub> - 2.1V	
I <sub>OLD</sub>	Minimum Dynamic	5.5			75	mA	V <sub>OLD</sub> = 1.65V Max	
I <sub>OHD</sub>	Output Current(Note 6)	5.5			-75	mA	V <sub>OHD</sub> = 3.85V Min	
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5		4.0	40.0	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND	

**Note 5:** All outputs loaded; thresholds on input associated with output under test.  
**Note 6:** Maximum test duration 2.0 ms, one output loaded at a time.

AC Electrical Characteristics for AC								
Symbol	Parameter	V <sub>CC</sub> (V) (Note 7)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF		Units
			Min	Typ	Max	Min	Max	
f <sub>MAX</sub>	Maximum Clock Frequency	3.3	149	214		139		MHz
		5.0	187	244		187		
t <sub>PLH</sub>	Propagation Delay CP to Q <sub>n</sub> or $\overline{Q}_n$	3.3	2.0	9.5	12.0	2.0	13.5	ns
		5.0	1.5	7.0	9.0	1.0	9.5	
t <sub>PHL</sub>	Propagation Delay CP to Q <sub>n</sub> or $\overline{Q}_n$	3.3	2.5	8.5	13.0	2.0	14.5	ns
		5.0	1.5	6.0	9.5	1.5	10.5	
t <sub>PLH</sub>	Propagation Delay $\overline{MR}$ to $\overline{Q}_n$	3.3	3.0	7.5	12.5	2.5	13.5	ns
		5.0	2.0	5.5	9.0	1.5	10.0	
t <sub>PHL</sub>	Propagation Delay $\overline{MR}$ to Q <sub>n</sub>	3.3	3.0	8.5	11.0	2.5	12.5	ns
		5.0	2.0	6.0	8.5	1.5	9.0	

**Note 7:** Voltage Range 3.3 is 3.3V ± 0.3V  
Voltage Range 5.0 is 5.0V ± 0.5V

### AC Operating Requirements for AC

Symbol	Parameter	V <sub>CC</sub> (V) (Note 8)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF		Units
			Typ	Guaranteed Minimum			
t <sub>S</sub>	Setup Time, HIGH or LOW D <sub>n</sub> to CP	3.3	2.0	4.5	4.5		ns
		5.0	1.0	3.0	3.0		
t <sub>H</sub>	Hold Time, HIGH or LOW D <sub>n</sub> to CP	3.3	1.0	1.0	1.0		ns
		5.0	1.0	1.0	1.0		
t <sub>W</sub>	CP Pulse Width HIGH or LOW	3.3	2.5	4.5	4.5		ns
		5.0	2.0	3.5	3.5		
t <sub>W</sub>	MR Pulse Width, LOW	3.3	2.5	4.5	5.0		ns
		5.0	2.0	3.5	3.5		
t <sub>REC</sub>	Recovery Time MR to CP	3.3	-2.0	0	0		ns
		5.0	-1.0	0	0		

Note 8: Voltage Range 3.3 is 3.3V ± 0.3V  
Voltage Range 5.0 is 5.0V ± 0.5V

### AC Electrical Characteristics for ACT

Symbol	Parameter	V <sub>CC</sub> (V) (Note 9)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF		Units
			Min	Typ	Max	Min	Max	
f <sub>MAX</sub>	Maximum Clock Frequency	5.0	175	236		145		MHz
t <sub>PLH</sub>	Propagation Delay CP to Q <sub>n</sub> or $\overline{Q}_n$	5.0	2.0	6.0	10.0	1.5	11.0	ns
t <sub>PHL</sub>	Propagation Delay CP to Q <sub>n</sub> or $\overline{Q}_n$	5.0	2.0	7.0	11.0	1.5	12.0	ns
t <sub>PLH</sub>	Propagation Delay $\overline{MR}$ to $\overline{Q}_n$	5.0	2.0	6.0	9.5	1.5	10.5	ns
t <sub>PHL</sub>	Propagation Delay MR to Q <sub>n</sub>	5.0	2.0	5.5	9.5	1.5	10.5	ns

Note 9: Voltage Range 5.0 is 5.0V ± 0.5V

### AC Operating Requirements for ACT

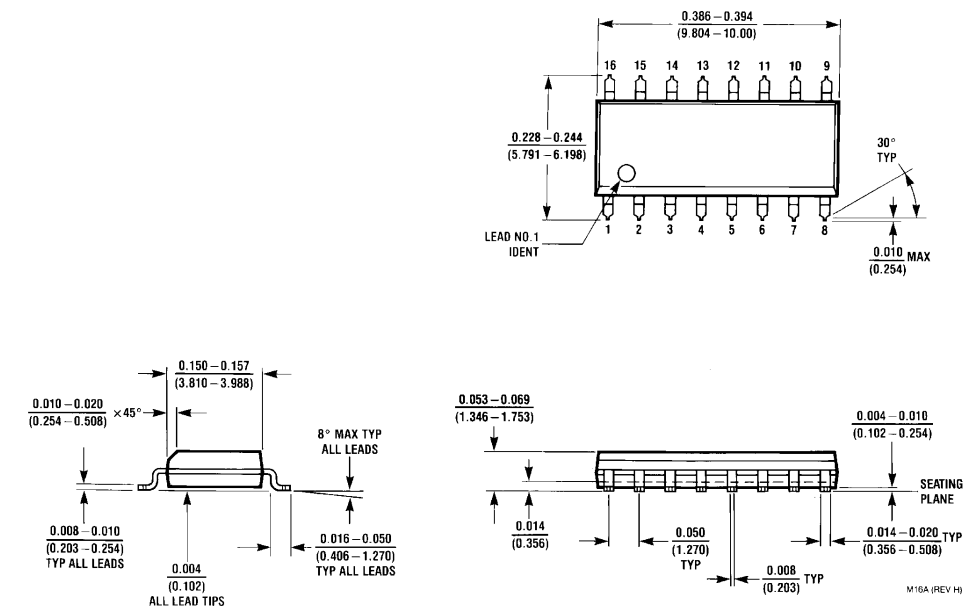
Symbol	Parameter	V <sub>CC</sub> (V) (Note 10)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF		Units
			Typ	Guaranteed Minimum			
t <sub>S</sub> (H)	Setup Time D <sub>n</sub> to CP	5.0	3.0	2.0	2.0		ns
t <sub>S</sub> (L)			3.0	2.5	2.5		
t <sub>H</sub>	Hold Time, HIGH or LOW D <sub>n</sub> to CP	5.0	0	1.0	1.0		ns
t <sub>W</sub>	CP Pulse Width HIGH or LOW	5.0	4.0	3.0	3.5		ns
t <sub>W</sub>	MR Pulse Width, LOW	5.0	4.0	3.0	4.0		ns
t <sub>rec</sub>	Recovery Time, $\overline{MR}$ to CP	5.0	0	0	0		ns

Note 10: Voltage Range 5.0 is 5.0V ± 0.5V

### Capacitance

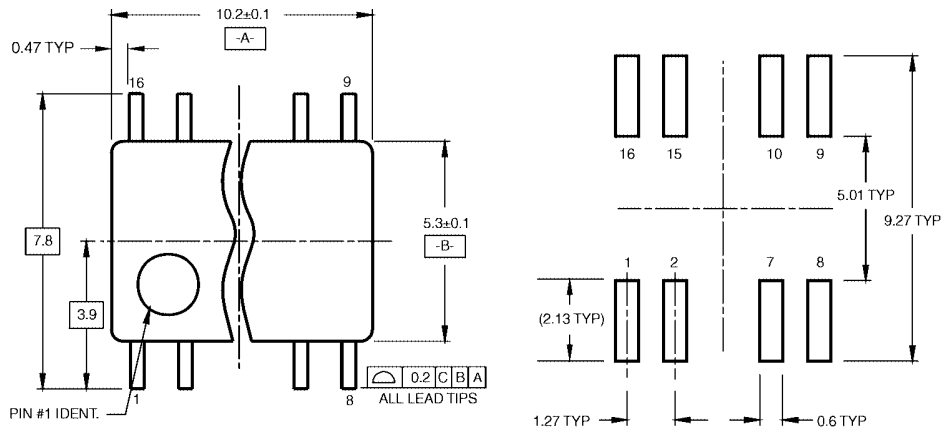
Symbol	Parameter	Typ	Units	Conditions
C <sub>IN</sub>	Input Capacitance	4.5	pF	V <sub>CC</sub> = OPEN
C <sub>PD</sub>	Power Dissipation Capacitance	45.0	pF	V <sub>CC</sub> = 5.0V

**Physical Dimensions** inches (millimeters) unless otherwise noted

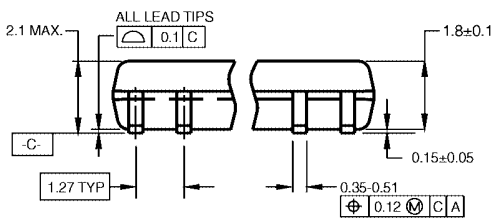


**16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow Body  
Package Number M16A**

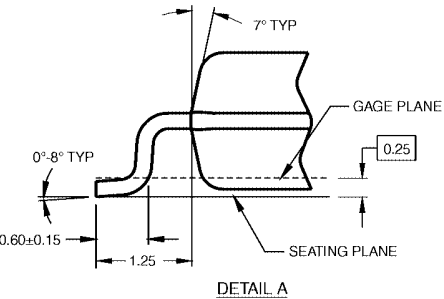
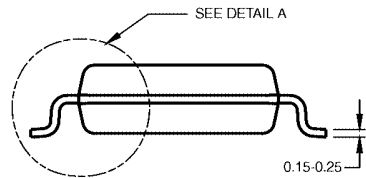
**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS

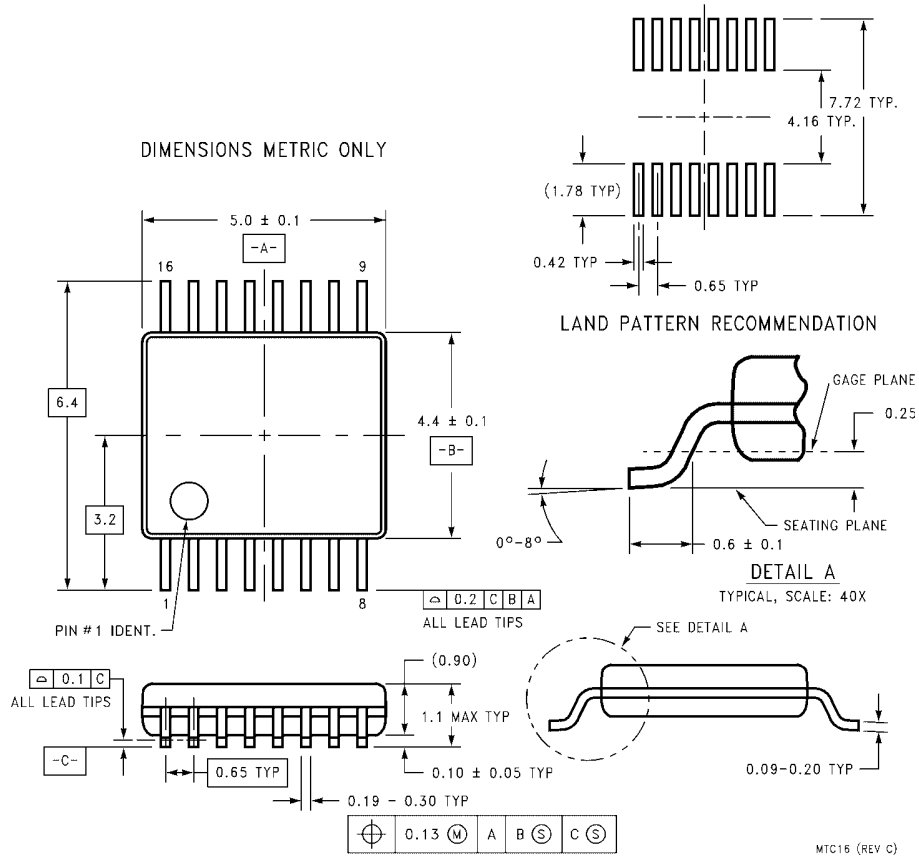


- NOTES:  
 A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.  
 B. DIMENSIONS ARE IN MILLIMETERS.  
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1

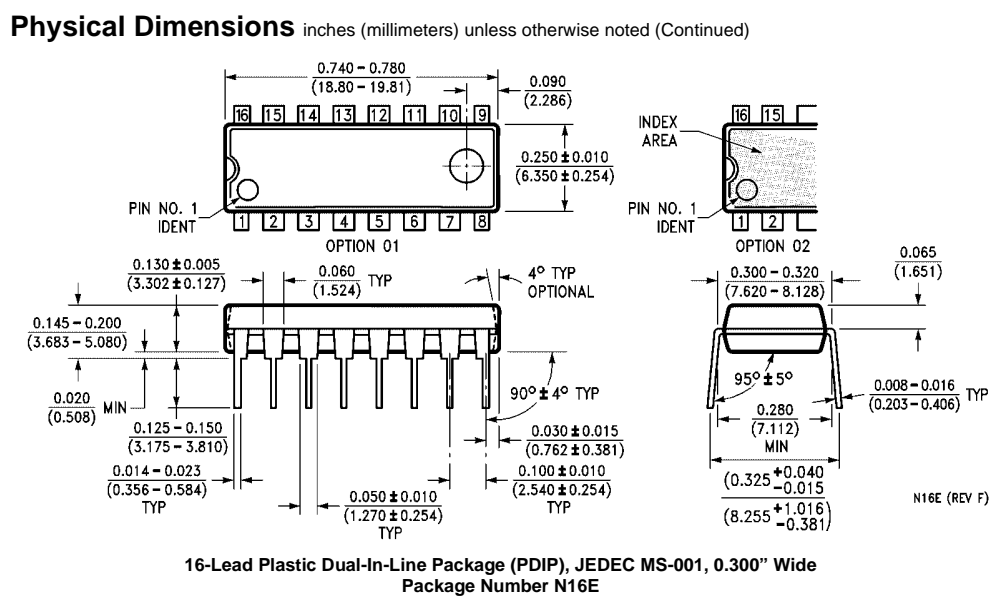
**16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide  
 Package Number M16D**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC16**





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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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